

TDA18273HN

Hybrid (analog and digital) Silicon Tuner for terrestrial and cable TV reception

Rev. 3 — 10 May 2011

Product short data sheet

1. General description

The TDA18273HN is a high performance Silicon Tuner designed for terrestrial and cable TV reception for both analog and digital signals.

The TDA18273HN supports all analog and digital TV standards and delivers a LOW IF (LIF) signal to a demodulator for analog TV and/or a channel demodulator for digital TV.

2. Features and benefits

- Fully integrated IF selectivity; eliminating the need for external SAW filters
- Worldwide multistandard terrestrial and cable
- Fully integrated oscillators
- Alignment free
- Single 3.3 V supply voltage
- Power level detector
- Integrated wideband gain control
- Crystal oscillator output buffer (16 MHz) for single crystal applications
- I²C-bus interface compatible with 3.3 V microcontrollers
- Self AGC synchronization mode (VSYNC)
- Very fast tuning time
- LIF channel center frequency output ranging from 3 MHz to 5 MHz
- 1.7 MHz, 6 MHz, 7 MHz, 8 MHz and 10 MHz channel bandwidths
- Ready for DVB-T2 and DVB-C2
- RoHS compliant
- Strong immunity to spurious and field interferences

3. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f_{RF}	RF frequency	full range of RF input	42	-	870	MHz
NF_{tun}	tuner noise figure	75 Ω source; maximum gain	-	4.0	4.6	dB
Φjit	phase jitter	UHF; integrated from 250 Hz to 4 MHz	-	0.4	0.6	degree



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Table 1. Quick reference data ...continued

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
α _{image}	image rejection	worst case for image rejection, at 4 MHz IF frequency and for image levels above 60 dB _μ V		57.5	63	-	dB
CSO	composite second-order distortion	worst interferer over RF frequency with respect to wanted carrier	[1]	-	-60	-55	dBc
СТВ	composite triple beat	worst interferer over RF frequency with respect to wanted carrier for frequency ≤ 550 MHz		-	-65	-60	dBc
		worst interferer over RF frequency with respect to wanted carrier for frequency > 550 MHz		-	-	-55	dBc
ICP _{1dB}	1 dB input compression point	at tuner input and minimum gain		122	-	-	dBμV

^[1] Channel loading assumptions: 129 channels at 75 dB μ V each.

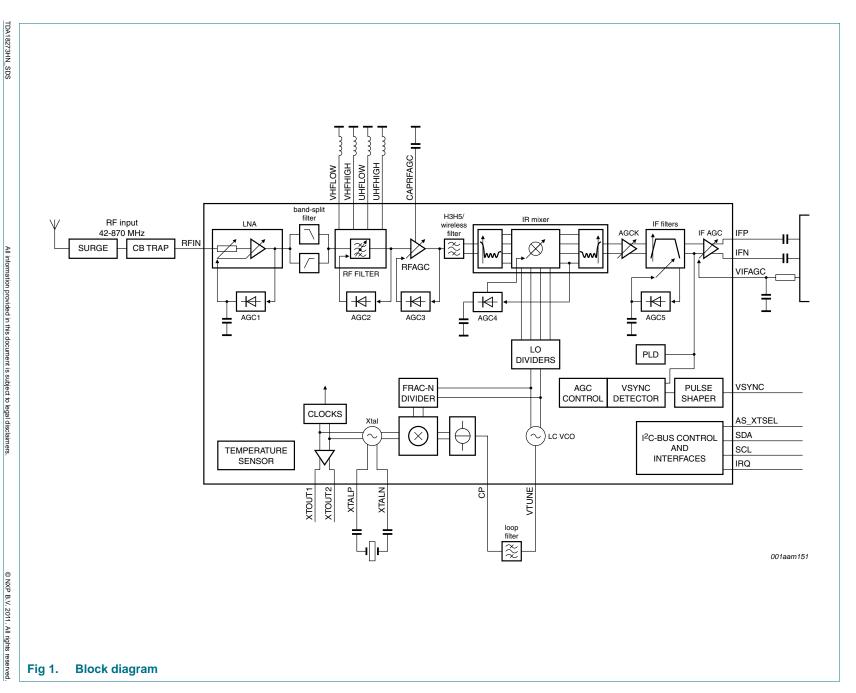
4. Ordering information

Table 2. Ordering information

Type number	Package				
	Name	Description	Version		
TDA18273HN/C1	HVQFN40	plastic thermal enhanced very thin quad flat package; no leads; 40 terminals; body $6\times6\times0.85$ mm	SOT618-1		

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51 **Block diagram**



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6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.3	+3.6	V
VI	input voltage	V _{CC} < 3.3 V	-0.3	$V_{CC} + 0.3$	V
		V _{CC} > 3.3 V	-0.3	+3.6	V
T _{stg}	storage temperature		-40	+150	°C
Tj	junction temperature		-	125	°C
T _{amb}	ambient temperature		-20	<u>[1]</u>	°C
V_{ESD}	electrostatic discharge voltage	EIA/JESD22-A114 (HBM)	-2	+2	kV
		EIA/JESD22-C101-C (FCDM) class III[2]	750	-	V

^[1] The maximum allowed ambient temperature $T_{amb(max)}$ depends on the assembly conditions of the package and especially on the design of the Printed-Circuit Board (PCB) and die connection. The application mounting must be done in such a way that the maximum junction temperature is never exceeded. The junction temperature can be obtained by reading the temperature sensor bit via I^2C -bus. The junction temperature: $T_j = T_{amb} + \Delta T_{j-c}$, where $\Delta T_{j-c} = power \times R_{th}$.

7. Abbreviations

Table 4. Abbreviations

Acronym	Description
AGC	Automatic Gain Control
AGCK	Automatic Gain Control step Killer
СВ	Citizen Band
DVB	Digital Video Broadcasting
DVB-T/T2/C/C2/H	DVB-Terrestrial/Terrestrial second generation/Cable/Handheld
FCDM	Field-induced Charged-Device Model
FRAC-N	Fractional-N
HBM	Human Body Model
IF	Intermediate Frequency
IR	Image Rejection
LC-VCO	Inductors and Capacitors - Voltage Controlled Oscillator
LNA	Low-Noise Amplifier
LO	Local Oscillator
PCB	Printed-Circuit Board
PLD	Power Level Detector
RF	Radio Frequency
RoHS	Restriction of Hazardous Substances
SAW	Surface Acoustic Wave
UHF	Ultra High Frequency

^[2] Class III: 500 V to 1000 V.

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 Table 4.
 Abbreviations ...continued

Acronym	Description
VHF	Very High Frequency
VSYNC	Vertical SYNChronization
Xtal	Crystal

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8. Revision history

Table 5. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
TDA18273HN_SDS v.3	20110510	Product short data sheet	-	TDA18273HN_SDS v.2
TDA18273HN_SDS v.2[1]	20101215	Preliminary short data sheet	-	-

^[1] Revision 1 is not available.

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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